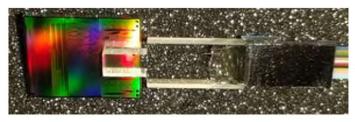
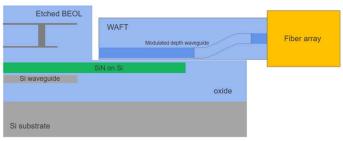


WAFT Series

The Silicon Chip-to-Fiber Interface Solution

DESCRIPTION





The Evanescent-Coupling Waveguide Array to Fiber Transposer (EV-WAFT) is an advanced PIC-to-fiber interposer tailored to combine the benefits of spot-size converters and gratings couplers. It allows for light transfer directly from a fiber array to the photonic layer of the photonic integrated circuit. This transfer leverages the evanescent electric field interaction between the ioNext glass waveguide and the Si/SiN tapers, which have previously been exposed through cladding removal.

This interposer can handle **any I/O configuration**, while the improved alignment tolerance and its seethrough feature make it **compatible with passive-alignment** assembly.

KEY FEATURES

| Number of ports | < 32 | [32 – 96] | [96 -256] |
|--|------------------------------------|-------------|-------------|
| Max Insertion Loss * (dB) | 0.7 0.9 1.1 | | |
| Insertion Loss Uniformity * (dB) | < 0.2 < 0.3 < 0.3 | | |
| Max Polarization Dependent Loss (dB) | on Dependent Loss (dB) 0.1 0.2 0.2 | | |
| Max Adjacent Crosstalk (dB) | -30 | -30 | -25 |
| Typical evanescent interaction length (mm) | 3 | | |
| Minimum Output Pitch (µm) | 20 | | |
| Outputs Positioning Relative Accuracy (µm) | +/- 0.05 +/- 0.1 | | |
| Polarization Extinction Ratio (dB) | > 25 | | |
| Operating wavelength (nm) | 1200 - 1700 | | |

^{*} without connectors

OPTIONS

- Fibre connection
 - SM or PM fibres
 - FC, SC, ST, LC or MPO connectors
- Custom chip designs :
 - Variable output pitches
 - Additional optical functions (taps, splitters...)

 Custom chip dimensions and shaping for footprint reduction



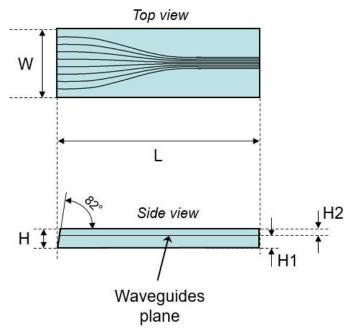
Contact us : Phone : +33 (0) 476 040 322 E-mail: sales@teemphotonics.com Web : www.teemphotonics.com



WAFT Series

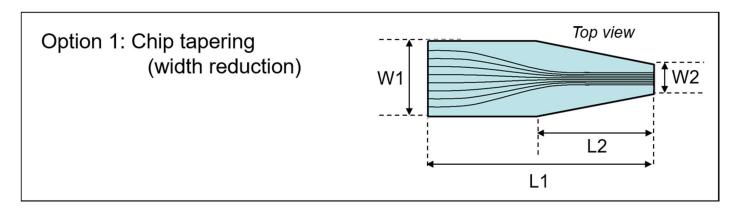
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STANDARD EV-WAFT CHIP SHAPE



- · W and L depends on :
 - the number of ports
 - input and output pitch
- $H1 = 1.5 \pm 0.05 \text{ mm}$
- $H2 = 2 \mu m$

SHAPING OPTIONS





WAFT Series The Silicen Chip to Fiber Interface Solution

PART NUMBER DESCRIPTION

| P/N: EC-WAFT-NC-IP-OP-SO-FO-FT-FA-CT | | |
|--------------------------------------|--------------------|---|
| NC | Number of Channels | From 1 to 256 |
| IP | Input Pitch | 127 or 250 μm |
| OP | Output Pitch | Down to 20 μm |
| so | Shaping Option | 00 : No option CM : Custom |
| FO | Fibering Option | 0 : Bare chip F : Chip pigtailed with fiber array |
| FT | Fiber Type | SM : SMF28 PM : PM1550 CM : Custom |
| FA | Fiber Arrangement | SF : Singulated fibers FR : Fiber ribbon |
| СТ | Connector Type | FC, SC, LC, ST, MPO |

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